10/574800

IAP15 Rec'd PCT/PTO 06 APR 2006

Application Data Sheet

Application Information

Application number: Unknown

Filing Date: April 6, 2006

Application Type: Regular

Title: PRESSURE-SENSITIVE ADHESIVE SHEET

AND METHOD OF MANUFACTURING THE

SAME

Attorney Docket Number: 24-033-TN

Applicant Information

Applicant No. 1

Applicant Authority Type: Inventor

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Status: Full Capacity

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Applicant Authority Type:

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Name of Assignee: LINTEC Corporation

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Correspondence Information

Correspondence Customer Number: 23400

Representative Information

Representative Customer Number: 23400

Foreign Priority Information

Country: Application Number: Filing Date: Priority Claimed:

PCT PCT/JP2004/013122 September 9, 2004 YES JAPAN 2003-352297 October 10, 2003 YES